

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Daewoong Suh  
Title: SOLDERING AN ELECTRONICS PACKAGE TO A MOTHERBOARD  
  
Docket No.: 884.C25US1 Serial No.: 10/808,192  
Filed: March 24, 2004 Due Date: December 21, 2007  
Examiner: Jonathan Johnson Group Art Unit: 1793

MS Issue Fee  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

We are transmitting herewith the following attached items (as indicated with an "X"):

X Applicant Interview Summary (1 pg.).

If not provided for in a separate paper filed herewith, Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

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